

# 10GBASE -LRM SFP+ 1310 nm 220m DOM Transceiver

EX-SFP-10GE-LRM-LL



## Application

- 10GBASE-LRM 10G Ethernet
- Legacy FDDI multimode links

## Features

- Hot-pluggable SFP+ footprint
- Supports 10.3 Gb/s bit rates
- Power dissipation < 1W
- RoHS-6 compliant (lead-free)
- Commercial temperature range 0° C to 70° C
- Single 3.3V power supply
- Maximum link length of 220m
- Uncooled directly modulated
- Fabry-Perot (FP) laser at 1310nm
- Receiver linear electrical interface
- Duplex LC connector
- Built-in digital diagnostic functions

## Description

10Gb/s Enhanced Small Form Factor Pluggable SFP+ transceivers are designed for use in 10-Gigabit Ethernet links up to 220m over Multi Mode fiber. They are compliant with SFF-8431, SFF-8432 and IEEE 802.3 aq 10GBASE-LRM. Digital diagnostics functions are available via a 2-wire serial interface, as specified in SFF-8472 .

The transceiver is a “linear module” i.e. it employs a linear receiver. Host board designers using an EDC PHY IC should follow the IC manufacturer’s recommended settings for interoperating the host board EDC PHY with a linear receiver SFP+ module. The optical transceivers are compliant per the RoHS Directive 2011/65/EU. See Finisar Application Note AN-2038 for more details.

## Product Specifications

### I.General Specifications

Parameter	Symbol	Min	Typ.	Max	Unit	Ref.
<b>Bit Rate</b>	BR		10.3125		Gb/s	1
<b>Bit Error Ratio</b>	BER			10 <sup>-12</sup>		2

### Maximum Supported Distances

Fiber Type	1310nm OFL Bandwidth	Lmax	Unit	Ref.
<b>62.5µm</b>	“FDDI” 160MHz-km	Lmax	220	3
	OM1 200MHz-km		220	
<b>50µm</b>	400 MHz-km	Lmax	100	3
	OM2 500 MHz-km		220	
	OM3 2000 MHz-km		220	

#### Notes:

1. 10GBASE-LRM
2. Tested with a 2 31 – 1 PRBS
3. Operating range as defined by IEEE standards. Longer reach possible depending upon link implementation.

## II. Absolute Maximum Ratings

Parameter	Symbol	Min	Typ.	Max	Unit	Ref.
Maximum Supply Voltage	V <sub>CC</sub>	-0.5		4.0	V	
Storage Temperature	T <sub>S</sub>	-40		85	° C	
Relative Humidity	RH	0		85	%	1

### Notes:

1. Non-condensing.

## III. Electrical Characteristics (TOP= 0 to 70 ° C, VCC = 3.14 to 3.46 Volts)

Parameter	Symbol	Min	Typ.	Max	Unit	Ref.
Supply Voltage	V <sub>CC</sub>	3.14		3.46	V	
Supply Current	I <sub>CC</sub>		200	300	mA	
Power Dissipation	P			1.0	W	

### Transmitter

Input differential impedance	R <sub>in</sub>		100		Ω	1
Differential data input swing	V <sub>in,pp</sub>	90		350	mV	2
Transmit Disable Voltage	V <sub>D</sub>	2		V <sub>CC</sub>	V	3
Transmit Enable Voltage	V <sub>EN</sub>	V <sub>EE</sub>		V <sub>EE</sub> + 0.8	V	

### Receiver

Termination Mismatch at 1 MHz	ΔZ <sub>M</sub>			5	%	
Single Ended Output Voltage Tolerance		-0.3		4.0	V	
Output AC Common Mode Voltage				7.5	mV RMS	
Output Rise and Fall time (20% to 80%)	T <sub>r</sub> , T <sub>f</sub>	30			Ps	4

### Receiver

<b>Relative Noise LRM Links with crosstalk</b>	RN	per SFF-8431				5
<b>Difference Waveform Distortion Penalty</b>	dWDP	per SFF-8431			dBo	5,6
<b>Differential Voltage Modulation Amplitude</b>	VMA	180		600	mV	
<b>LOS Fault</b>	$V_{\text{LOS fault}}$	2		$V_{\text{CC HOST}}$	V	7
<b>LOS Normal</b>	$V_{\text{LOS norm}}$	Vee		Vee+0.8	V	7
<b>Power Supply Noise Tolerance</b>	$V_{\text{CC T}}/V_{\text{CC R}}$	per SFF-8431			mVpp	8

**Notes:**

1. Connected directly to TX data input pins. AC coupling from pins into laser driver IC.
2. Per SFF-8431 Rev 4.1
3. Into 100 ohms differential termination.
4. Measured with Module Compliance Test Board and OMA test pattern.
5. Values shown in Table 20, SFF-8431. dWDP and RN is calculated by the following equation:  

$$RN \leq \min[(m1 \times dWDP + b1), (m2 \times dWDP + b2), RN_{max}]$$
6. Defined with reference receiver with 14 T/2 spaced FFE taps and 5 T spaced DFE taps.
7. LOS is an open collector output. Should be pulled up with 4.7k – 10kΩ on the host board. Normal operation is logic 0; loss of signal is logic 1. Maximum pull-up voltage is 5.5V.
8. As described in Section 2.8.1, SFF-8431 Rev 4.1.

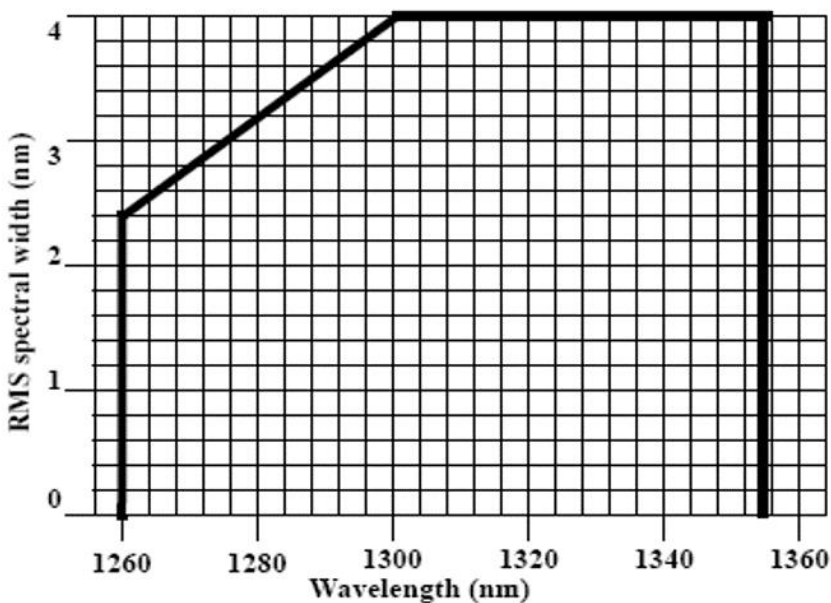
**IV. Optical Characteristics (TOP = 0 to 70 °C, VCC = 3.14 to 3.46 V)**

Parameter	Symbol	Min	Typ.	Max	Unit	Ref.
<b>Transmitter (Tx)</b>						
<b>Optical Modulation Amplitude (OMA)</b>	$P_{OMA}$	-4.5		+1.5	dBm	
<b>Average Launch Power</b>	$P_{AVE}$	-6.5		0.5	dBm	1
<b>Peak Launch Power</b>	$P_{MAX}$			3	dBm	
<b>Optical Wavelength</b>	$\lambda$	1260		1355	nm	
<b>RMS Spectral Width</b>	$\lambda_{rms}$ @1260nm			2.4		
	$\lambda_{rms}$ @ 1260nm- 1300nm			See Figure as below	nm	2
	$\lambda_{rms}$ @ 1300nm- 1355nm			4		
<b>Optical Extinction Ratio</b>	ER	3.5			dB	
<b>Optical Eye Mask Margin</b>		0			%	3
<b>Transmitter Waveform Dispersion Penalty</b>	TWDP			4.7	dB	4

<b>Average Launch power of OFF transmitter</b>	$P_{OFF}$			-30	dBm	
<b>Uncorrelated Jitter [rms]</b>	$T_{Xj}$			0.033	UI	
<b>Relative Intensity Noise</b>	$RIN_{12OMA}$			-128	dB/Hz	
<b>Encircled Flux</b>	<5 $\mu$ m <11 $\mu$ m	30 81			%	
<b>Transmitter Reflectance</b>				-12	dB	
<b>Optical Return Loss Tolerance</b>		20			dB	
<b>Receiver (Rx)</b>						
<b>Receiver Overload</b>	POMA	+1.5			dBm	5
	Precursor			-6.5		
<b>Comprehensive Stressed Receiver Sensitivity (OMA) @ 10.3125Gb/s</b>	Symmetrical			-6.0	dBm	6
	Postcursor			-6.5		
<b>Wavelength Range</b>	$\lambda_C$	1260		1355	$N_m$	
<b>Receiver Reflectance</b>	$R_{rx}$			-12	dB	
<b>LOS De-Assert</b>	$LOS_D$			-11	dBm	
<b>LOS Assert</b>	$LOS_A$	-30			dBm	
<b>LOS Hysteresis</b>		0.5			dB	

**Notes:**

1. Average power figures are informative only, per IEEE802.3aq
2. Maximum RMS spectral width as specified by Figure as below
3. Optical Eye Mask requires the host board to be SFF-8431 compliant. Optical eye mask per IEEE802.3aq.
4. TWDP figure requires the host board to be SFF-8431 compliant. TWDP is calculated
5. using the Matlab code provided in clause 68.6.6.2 of IEEE802.3aq Receiver overload specified in OMA and under the worst comprehensive stressed condition.
6. Conditions of stressed receiver tests per IEEE802.3aq. CSRS testing requires the host board to be SFF-8431 compliant.



Transmitter Maximum RMS Spectral Width

### V.Digital Diagnostic Specifications

The transceiver can be used in host systems that require either internally or externally calibrated digital diagnostics.

Parameter	Symbol	Min	Typ.	Max	Units	Ref.
<b>Accuracy</b>						
<b>Internally measured transceiver temperature</b>	DD <sub>Temp</sub>			3	°C	
<b>Internally measured transceiver supply voltage</b>	DD <sub>Voltage</sub>			100	mV	
<b>Measured TX bias current</b>	DD <sub>Bias</sub>			10	%	1
<b>Measured TX output power</b>	DD <sub>Tx-Power</sub>			2	dB	
<b>Measured RX received average optical power</b>	DD <sub>Rx-Power</sub>			2	dB	

Parameter	Symbol	Min	Typ.	Max	Units	Ref.
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### Dynamic Range for Rated Accuracy

Internally measured transceiver temperature	DD <sub>Temp</sub>	-5		75	°C	
Internally measured transceiver supply voltage	DD <sub>Voltage</sub>	3.1		3.5	V	
Measured TX bias current	DD <sub>Bias</sub>	0		75	mA	
Measured TX output power	DD <sub>Tx-Power</sub>	-6.5		0.5	dBm	
Measured RX received average optical power	DD <sub>Rx-Power</sub>	-20		-10	dBm	

### Max Reporting Range

Internally measured transceiver temperature	DD <sub>Temp</sub>	-40		125	°C	
Internally measured transceiver supply voltage	DD <sub>Voltage</sub>	2.8		4.0	V	
Measured TX bias current	DD <sub>Bias</sub>	0		75	mA	
Measured TX output power	DD <sub>Tx-Power</sub>	-10		3	dBm	
Measured RX received average optical power	DD <sub>Rx-Powe</sub>	-22		0	dBm	

#### Note:

1. Accuracy of Measured Tx Bias Current is 10% of the actual Bias Current from the laser driver to the laser.

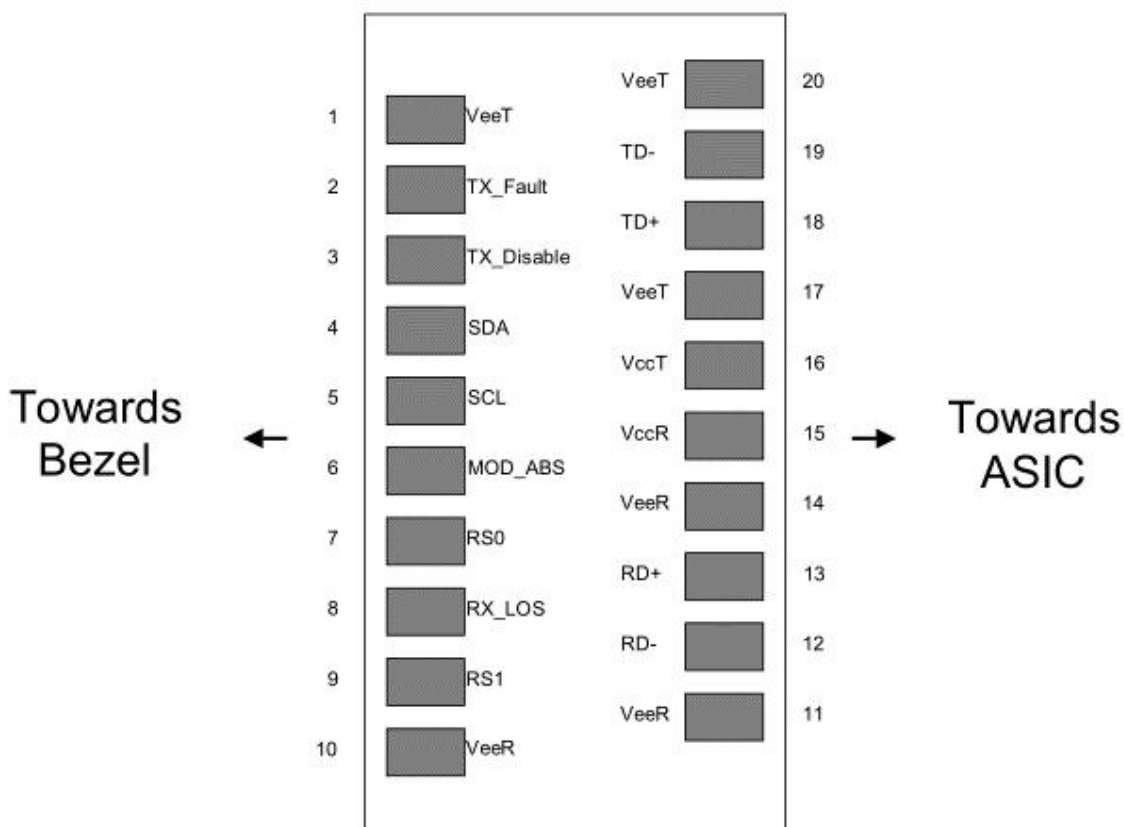


## VI. Pin Description

Pin	Symbol	Name/Description	Ref.
1	V <sub>EET</sub>	Transmitter Ground	1
2	T <sub>FAULT</sub>	Transmitter Fault	
3	T <sub>DIS</sub>	Transmitter Disable. Laser output disabled on high or open.	2
4	SDA	2-wire Serial Interface Data Line	3
5	SCL	2-wire Serial Interface Clock Line	3
6	MOD_ABS	Module Absent. Grounded within the module	3
7	RS0	No connection required	
8	RX_LOS	Loss of Signal indication. Logic 0 indicates normal operation.	4
9	RS1	No connection required	
10	V <sub>EER</sub>	Receiver Ground	1
11	V <sub>EER</sub>	Receiver Ground	1
12	RD-	Receiver Inverted DATA out. AC Coupled.	
13	RD+	Receiver Non-inverted DATA out. AC Coupled.	
14	V <sub>EER</sub>	Receiver Ground	1
15	V <sub>CCR</sub>	Receiver Power Supply	
16	V <sub>CCT</sub>	Transmitter Power Supply	
17	V <sub>EET</sub>	Transmitter Ground	1
18	TD+	Transmitter Non-Inverted DATA in. AC Coupled.	
19	TD-	Transmitter Inverted DATA in. AC Coupled.	
20	V <sub>EET</sub>	Transmitter Ground(Common with Receiver Ground)	1

**Notes:**

1. Circuit ground is internally isolated from chassis ground.
2. Laser output disabled on T DIS >2.0V or open, enabled on T DIS <0.8V.
3. Should be pulled up with 4.7kΩ – 10kΩ on host board to a voltage between 2.0V and 3.6V. MOD\_ABS pulls line low to indicate module is plugged in.
4. RX\_LOS is open collector output. Should be pulled up with 4.7kΩ – 10kΩ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.



## VII. Mechanical Specifications

